NTZS3151P

MOSFET – P-Channel, Small Signal, SOT-563

-20 V, -950 mA

Features

- Low R_{DS(on)} Improving System Efficiency
- Low Threshold Voltage
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switches
- Battery Management
- Cell Phones, Digital Cameras, PDAs, Pagers, etc.

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted.)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	-20	V
Gate-to-Source Voltage			V_{GS}	±8.0	V
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	I_	-860	mA
(Note 1)	State	T _A = 70°C	I _D	-690	
Power Dissipation (Note 1)	Steady State		P _D	170	mW
Continuous Drain Current	t ≤ 5 s	$T_A = 25^{\circ}C$	l_	-950	mA
(Note 1)	1 2 3 3	T _A = 70°C	I _D	-760	
Power Dissipation (Note 1)	t ≤ 5 s		P _D	210	mW
Pulsed Drain Current	t _p =	10 μs	I _{DM}	-4.0	Α
Operating Junction and Storage Temperature			T _J , T _{STG}	-55 to 150	°C
Source Current (Body Diode)			Is	-360	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			T_L	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	720	°C/W
$Junction-to-Ambient - t \le 5 s \text{ (Note 1)}$	$R_{\theta JA}$	600	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in. sq. pad size (Cu. area = 1.127 in. sq. [1 oz.] including traces).

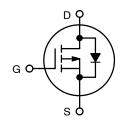


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	120 mΩ @ -4.5 V	
-20 V	144 mΩ @ –2.5 V	–950 mA
	195 mΩ @ –1.8 V	

P-Channel MOSFET



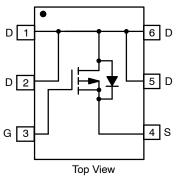




TX = Specific Device Code

M = Date Code
Pb-Free Package
(Note: Microdot may be in either location)

PINOUT: SOT-563



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted.)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-20			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-13		mV/°C	
Zero Gate Voltage Drain Current		V _{GS} = 0 V	T _J = 25°C			-1.0	μΑ	
	I _{DSS}	V _{DS} = -20 V	T _J = 125°C			-5.0		
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= ±8.0 V			±100	nA	
ON CHARACTERISTICS (Note 2)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= -250 μA	-0.45		-1.0	V	
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.4		mV/°C	
Drain-to-Source On Resistance		$V_{GS} = -4.5 \text{ V}, I_D$	= -950 mA		120	150	mΩ	
	Б	$V_{GS} = -4.5 \text{ V}, I_{D}$	= -770 mA		112	142	1	
	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D$	= -670 mA		144	200	1	
	$V_{GS} = -1.8 \text{ V}, I_D = -200 \text{ m}.$		= -200 mA		195	240	1	
Forward Transconductance	9FS	$V_{DS} = -10 \text{ V}, I_D$	= -810 mA		3.1		S	
CHARGES AND CAPACITANCES								
Input Capacitance	C _{ISS}	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = -16 \text{ V}$			458		pF	
Output Capacitance	C _{OSS}				61		1	
Reverse Transfer Capacitance	C _{RSS}				38		1	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V};$ $I_{D} = -770 \text{ mA}$			5.6		nC	
Threshold Gate Charge	Q _{G(TH)}				0.6		1	
Gate-to-Source Charge	Q _{GS}				0.9		1	
Gate-to-Drain Charge	Q_{GD}				1.2		1	
SWITCHING CHARACTERISTICS (Not	e 3)							
Turn-On Delay Time	t _{d(ON)}				5.0		ns	
Rise Time	t _r	V_{GS} = -4.5 V, V_{DD} = -10 V, I_{D} = -950 mA, R_{G} = 6.0 Ω			12		1	
Turn-Off Delay Time	t _{d(OFF)}				23.7		7	
Fall Time	t _f				18		1	
DRAIN-SOURCE DIODE CHARACTER	RISTICS							
Forward Diode Voltage	.,	V _{GS} = 0 V,	T _J = 25°C		-0.64	-0.9	V	
	V_{SD}	$I_{S} = -360 \text{ mA}$	T _J = 125°C		-0.5			
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, \text{ dI}_{S}/\text{dt} = 100 \text{ A}/\mu\text{s},$ $I_{S} = -360 \text{ mA}$			10.5		ns	

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES ($T_J = 25^{\circ}C$ unless otherwise noted)

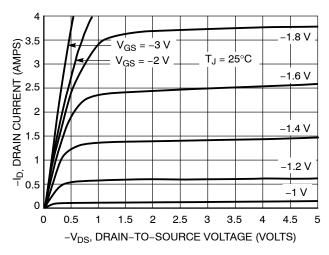


Figure 1. On-Region Characteristics

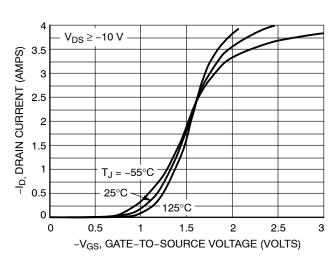


Figure 2. Transfer Characteristics

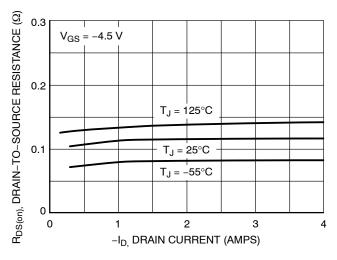


Figure 3. On-Resistance vs. Drain Current and Temperature

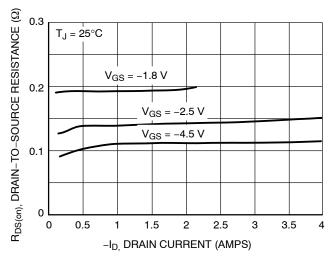


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

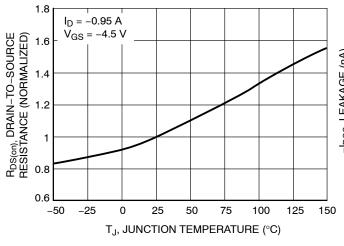


Figure 5. On–Resistance Variation with Temperature

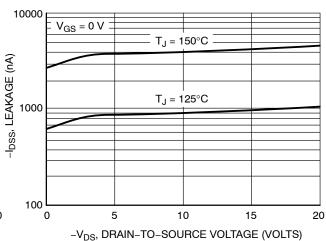
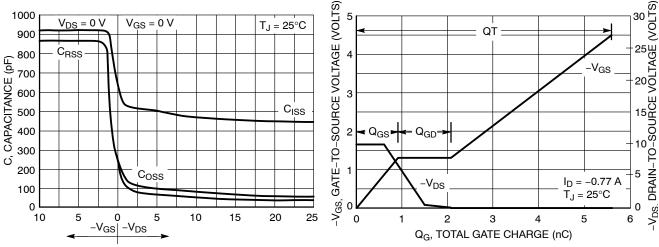


Figure 6. Drain-to-Source Leakage Current vs. Voltage

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TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

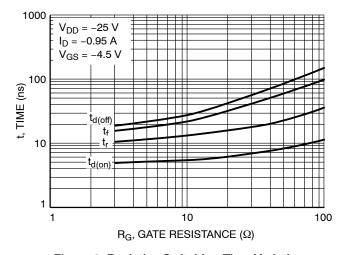


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

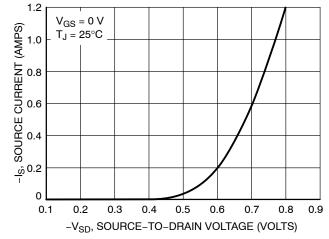


Figure 10. Diode Forward Voltage vs. Current

ORDERING INFORMATION

Device	Package	Shipping
NTZS3151PT1G	SOT-563 (Pb-Free)	4000 / Tape & Reel
NTZS3151PT1H	SOT-563 (Pb-Free)	4000 / Tape & Reel
NTZS3151PT5G	SOT-563 (Pb-Free)	8000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



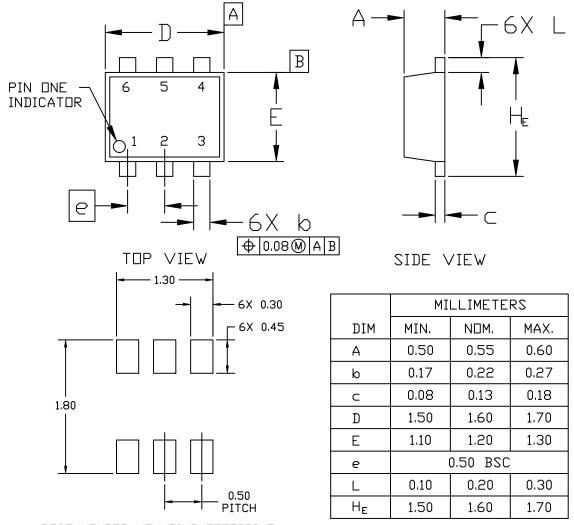


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DATE 26 JAN 2021

NOTES:

- I. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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DATE 26 JAN 2021

STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	STYLE 2: PIN 1. EMITTER 1 2. EMITTER 2 3. BASE 2 4. COLLECTOR 2 5. BASE 1 6. COLLECTOR 1	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE
STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE 5. CATHODE 6. CATHODE	STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	STYLE 8: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SDURCE 5. DRAIN 6. DRAIN	STYLE 9: PIN 1. SDURCE 1 2. GATE 1 3. DRAIN 2 4. SDURCE 2 5. GATE 2 6. DRAIN 1
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GENERIC MARKING DIAGRAM*



XX = Specific Device CodeM = Month Code= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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